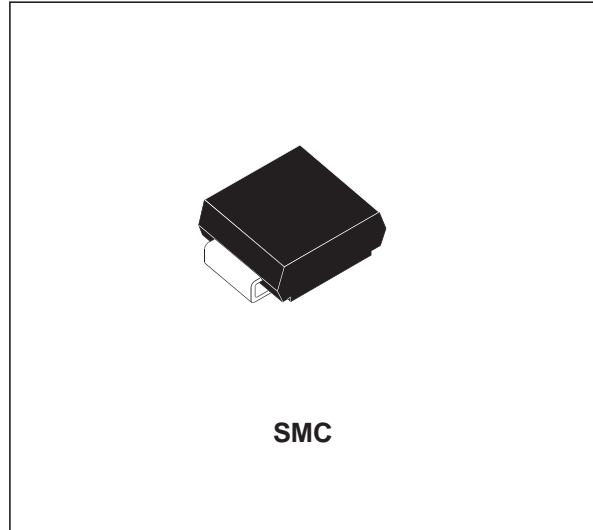


FEATURES

- PEAK PULSE POWER : 1500 W (10/1000µs)
- BREAKDOWN VOLTAGE RANGE :
From 6.8 V to 220 V
- UNI AND BIDIRECTIONAL TYPES
- LOW CLAMPING FACTOR
- FAST RESPONSE TIME
- UL RECOGNIZED

DESCRIPTION

Transil diodes provide high overvoltage protection by clamping action. Their instantaneous response to transient overvoltages makes them particularly suited to protect voltage sensitive devices such as MOS Technology and low voltage supplied IC's.



ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25^{\circ}\text{C}$)

| Symbol | Parameter | | Value | Unit |
|--------------------|--|--|----------------------|--|
| P_{PP} | Peak pulse power dissipation (see note1) | $T_j \text{ initial} = T_{amb}$ | 1500 | W |
| P | Power dissipation on infinite heatsink | $T_{amb} = 50^{\circ}\text{C}$ | 6.5 | W |
| I_{FSM} | Non repetitive surge peak forward current for unidirectional types | $t_p = 10\text{ms}$ $T_j \text{ initial} = T_{amb}$ | 200 | A |
| T_{stg} T_j | Storage temperature range Maximum junction temperature | | - 65 to + 175 150 | $^{\circ}\text{C}$ $^{\circ}\text{C}$ |
| T_L | Maximum lead temperature for soldering during 10 s. | | 260 | $^{\circ}\text{C}$ |

Note 1 : For a surge greater than the maximum values, the diode will fail in short-circuit.

THERMAL RESISTANCES

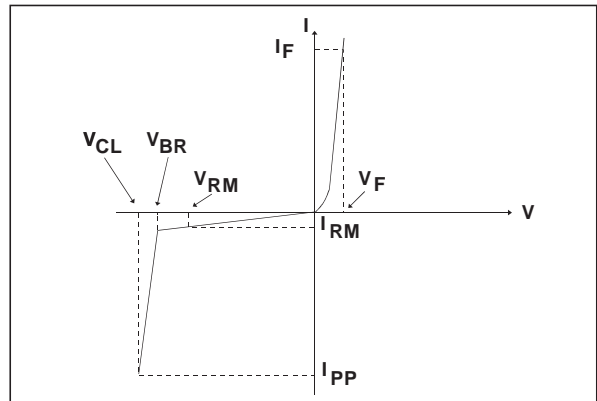
| Symbol | Parameter | Value | Unit |
|---------------|--|-------|-----------------------------|
| $R_{th(j-l)}$ | Junction to leads | 15 | $^{\circ}\text{C}/\text{W}$ |
| $R_{th(j-a)}$ | Junction to ambient on printed circuit on recommended pad layout | 75 | $^{\circ}\text{C}/\text{W}$ |

SM15Txx

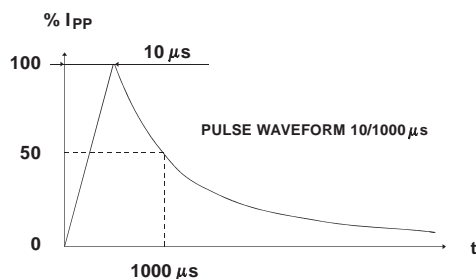
ELECTRICAL CHARACTERISTICS

(T_{amb} = 25°C)

| Symbol | Parameter |
|-----------------|-----------------------------------|
| V _{RM} | Stand-off voltage |
| V _{BR} | Breakdown voltage |
| V _{CL} | Clamping voltage |
| I _{RM} | Leakage current @ V _{RM} |
| I _{PP} | Peak pulse current |
| α _T | Voltage temperature coefficient |
| V _F | Forward Voltage drop |



| Types | | | | I _{RM} @ V _{RM} | | V _{BR} @ I _R | | | | V _{CL} @ I _{PP} | | V _{CL} @ I _{PP} | | α _T | C |
|-----------------|----------|----------------|----------|-----------------------------------|------|----------------------------------|-----|------|-----|-----------------------------------|------|-----------------------------------|-----|----------------------|------|
| Uni directional | Mar-king | Bi directional | Mar-king | max | max | min | nom | max | max | max | max | max | max | max | typ |
| | | | | μA | V | V | V | V | mA | V | A | V | A | 10 ⁻⁴ /°C | pF |
| SM15T6V8A | MDE | SM15T6V8CA | BDE | 1000 | 5.8 | 6.45 | 6.8 | 7.14 | 10 | 10.5 | 143 | 13.4 | 746 | 5.7 | 9500 |
| SM15T7V5A | MDG | SM15T7V5CA | BDG | 500 | 6.4 | 7.13 | 7.5 | 7.88 | 10 | 11.3 | 132 | 14.5 | 690 | 6.1 | 8500 |
| SM15T10A | MDP | SM15T10CA | BDP | 10 | 8.55 | 9.5 | 10 | 10.5 | 1 | 14.5 | 103 | 18.6 | 538 | 7.3 | 7000 |
| SM15T12A | MDT | SM15T12CA | BDT | 5 | 10.2 | 11.4 | 12 | 12.6 | 1 | 16.7 | 90 | 21.7 | 461 | 7.8 | 6000 |
| SM15T15A | MDX | SM15T15CA | BDX | 1 | 12.8 | 14.3 | 15 | 15.8 | 1 | 21.2 | 71 | 27.2 | 368 | 8.4 | 5000 |
| SM15T18A | MEE | SM15T18CA | BEE | 1 | 15.3 | 17.1 | 18 | 18.9 | 1 | 25.2 | 59.5 | 32.5 | 308 | 8.8 | 4300 |
| SM15T22A | MEK | SM15T22CA | BEK | 1 | 18.8 | 20.9 | 22 | 23.1 | 1 | 30.6 | 49 | 39.3 | 254 | 9.2 | 3700 |
| SM15T24A | MEM | SM15T24CA | BEM | 1 | 20.5 | 22.8 | 24 | 25.2 | 1 | 33.2 | 45 | 42.8 | 234 | 9.4 | 3500 |
| SM15T27A | MEP | SM15T27CA | BEP | 1 | 23.1 | 25.7 | 27 | 28.4 | 1 | 37.5 | 40 | 48.3 | 207 | 9.6 | 3200 |
| SM15T30A | MER | SM15T30CA | BER | 1 | 25.6 | 28.5 | 30 | 31.5 | 1 | 41.5 | 36 | 53.5 | 187 | 9.7 | 2900 |
| SM15T33A | MET | SM15T33CA | BET | 1 | 28.2 | 31.4 | 33 | 34.7 | 1 | 45.7 | 33 | 59.0 | 169 | 9.8 | 2700 |
| SM15T36A | MEV | SM15T36CA | BEV | 1 | 30.8 | 34.2 | 36 | 37.8 | 1 | 49.9 | 30 | 64.3 | 156 | 9.9 | 2500 |
| SM15T39A | MEX | SM15T39CA | BEX | 1 | 33.3 | 37.1 | 39 | 41.0 | 1 | 53.9 | 28 | 69.7 | 143 | 10.0 | 2400 |
| SM15T68A | MFP | SM15T68CA | BFP | 1 | 58.1 | 64.6 | 68 | 71.4 | 1 | 92 | 16.3 | 121 | 83 | 10.4 | 1550 |
| SM15T75A | MFO | SM15T75CA | BFO | 1 | 64.1 | 71.3 | - | 78.8 | 1 | 103 | 14.6 | 134 | 75 | 10.5 | 1450 |
| SM15T100A | MFX | SM15T100CA | BFX | 1 | 85.5 | 95.0 | 100 | 105 | 1 | 137 | 11 | 178 | 56 | 10.6 | 1150 |
| SM15T150A | MGK | SM15T150CA | BGK | 1 | 128 | 143 | 150 | 158 | 1 | 207 | 7.2 | 265 | 38 | 10.8 | 850 |
| SM15T200A | MGV | SM15T200CA | BGV | 1 | 171 | 190 | 200 | 210 | 1 | 274 | 5.5 | 353 | 28 | 10.8 | 675 |
| SM15T220A | MGX | SM15T220CA | BGX | 1 | 188 | 209 | 220 | 231 | 1 | 328 | 4.6 | 388 | 26 | 10.8 | 625 |



Note 2 : Pulse test: t_p < 50 ms.

Note 3 : ΔV_{BR} = α_T * (T_{amb} - 25) * V_{BR}(25°C).

Note 4 : V_R = 0 V, F = 1 MHz. For bidirectional types, capacitance value is divided by 2.

Fig. 1: Peak pulse power dissipation versus initial junction temperature (printed circuit board).

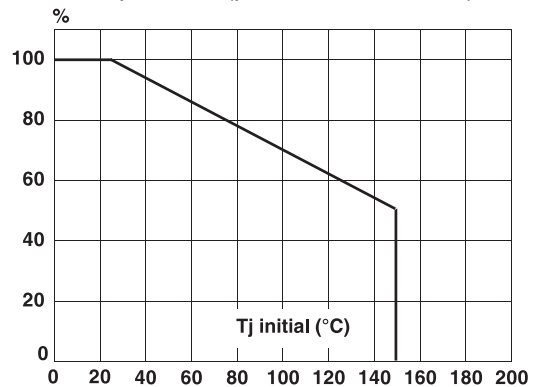


Fig. 2 : Peak pulse power versus exponential pulse duration.

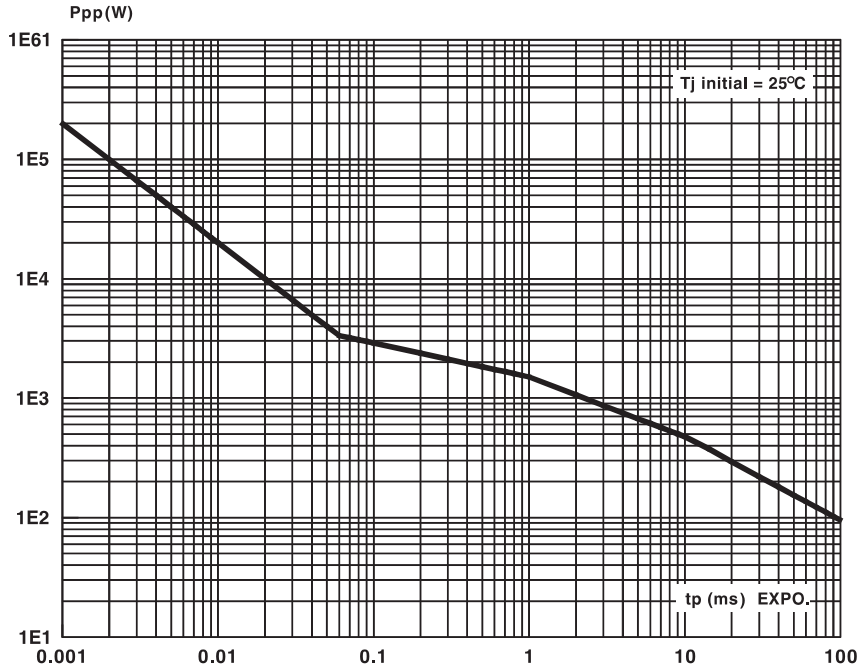
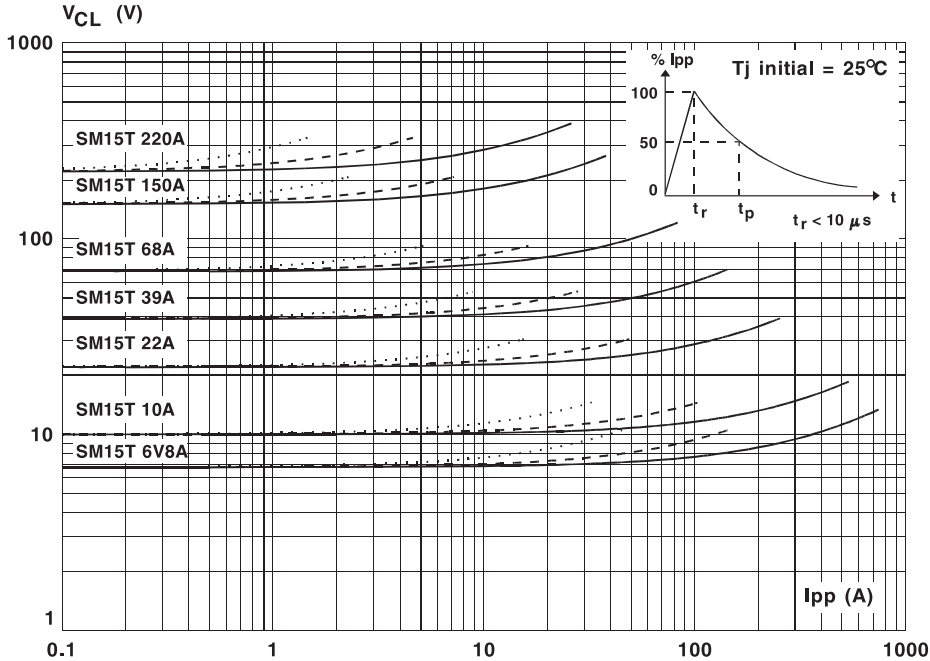


Fig. 3 : Clamping voltage versus peak pulse current.
 Exponential waveform $t_p = 20 \mu s$ _____
 $t_p = 1 ms$ _____
 $t_p = 10 ms$



Note : The curves of the figure 3 are specified for a junction temperature of 25 °C before surge.
 The given results may be extrapolated for other junction temperatures by using the following formula :
 $\Delta V_{BR} = \alpha T \cdot [T_{amb} - 25] + V_{BR}(25^\circ C)$.
 For intermediate voltages, extrapolate the given results.



SM15Txx

Fig. 4a : Capacitance versus reverse applied voltage for unidirectional types (typical values).

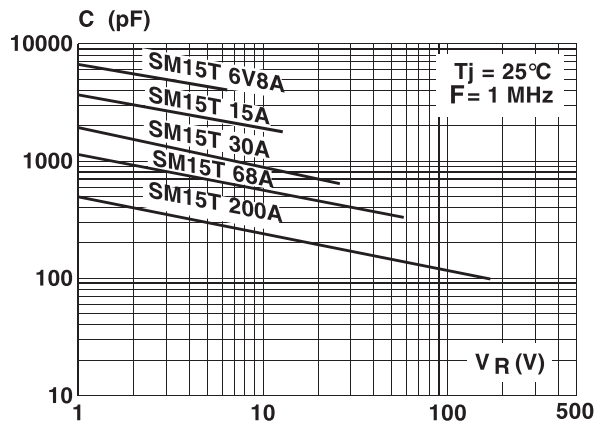


Fig. 4b : Capacitance versus reverse applied voltage for bidirectional types (typical values).

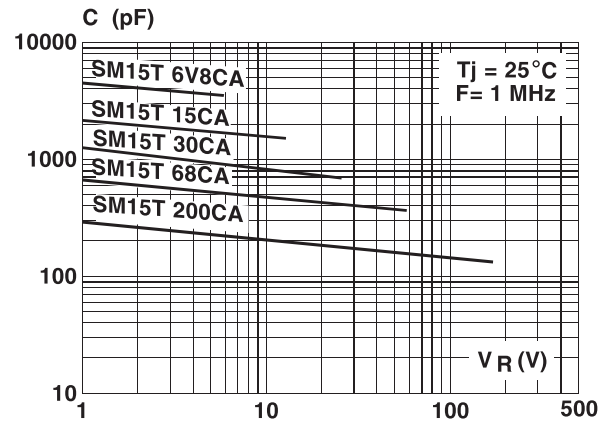


Fig. 5 : Peak forward voltage drop versus peak forward current (typical values for unidirectional types).

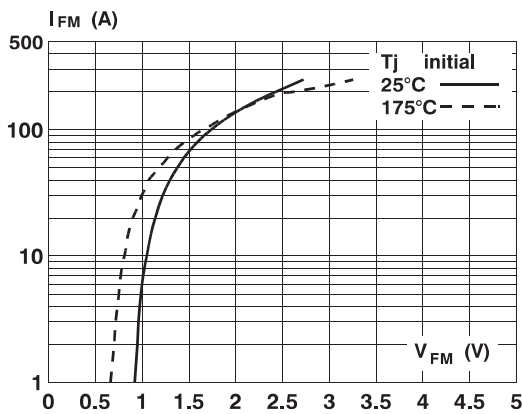


Fig. 6 : Transient thermal impedance junction-ambient versus pulse duration. Mounting on FR4 PC Board with recommended pad layout.

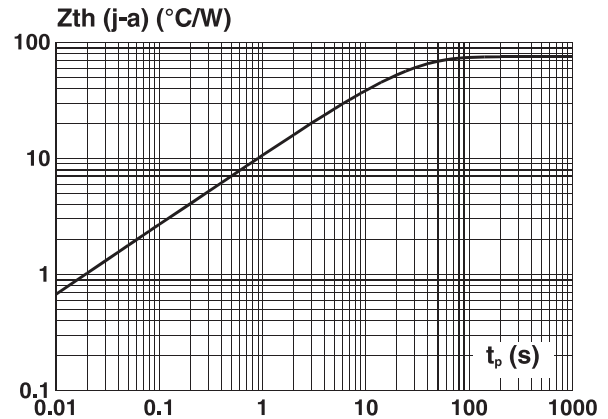
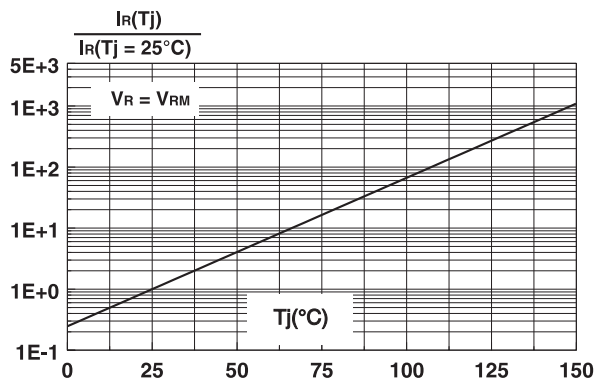
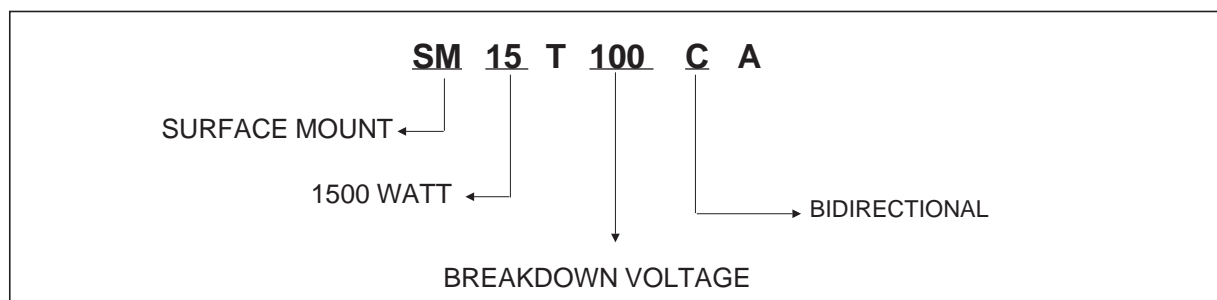


Fig. 7 : Relative variation of leakage current versus junction temperature.



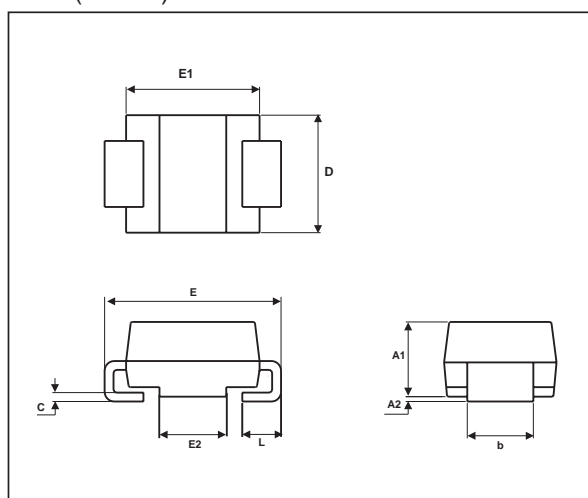
ORDER CODE



MARKING : Logo, Date Code, Type Code, Cathode Band (for unidirectional types only).

PACKAGE MECHANICAL DATA

SMC (Plastic)

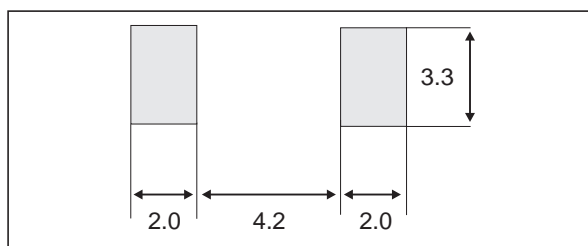


| REF. | DIMENSIONS | | | |
|------|-------------|------|--------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A1 | 1.90 | 2.45 | 0.075 | 0.096 |
| A2 | 0.05 | 0.20 | 0.002 | 0.008 |
| b | 2.90 | 3.2 | 0.114 | 0.126 |
| c | 0.15 | 0.41 | 0.006 | 0.016 |
| E | 7.75 | 8.15 | 0.305 | 0.321 |
| E1 | 6.60 | 7.15 | 0.260 | 0.281 |
| E2 | 4.40 | 4.70 | 0.173 | 0.185 |
| D | 5.55 | 6.25 | 0.218 | 0.246 |
| L | 0.75 | 1.60 | 0.030 | 0.063 |

Weight = 0.25 g.

FOOTPRINT DIMENSIONS (Millimeters)

SMC



Packaging : standard packaging is in tape and reel.

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